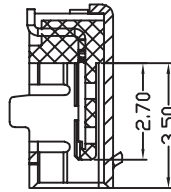
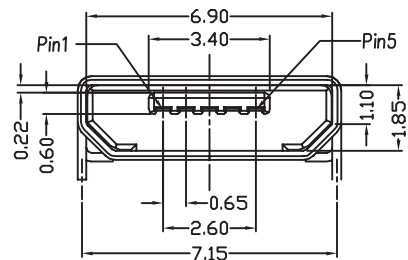
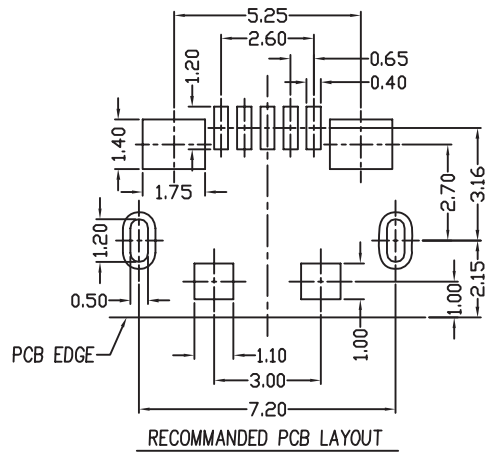
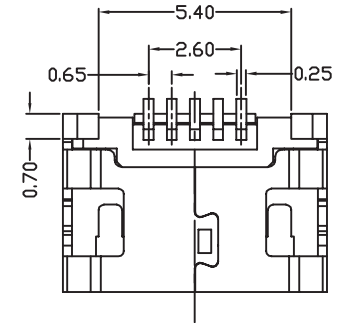
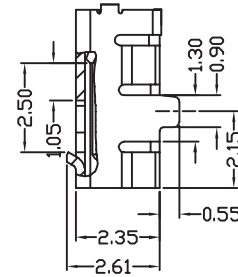
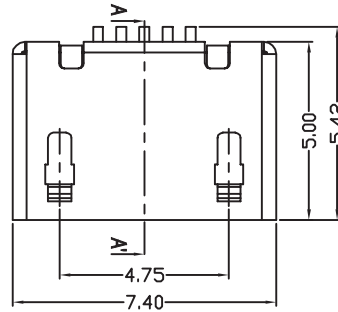
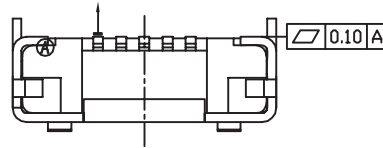


RoHS Compliant



SECTION A-A'



SPECIFICATIONS

1. MATERIAL:
 - 1.1 HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94V-0
 - 1.2 CONTACT: COPPER ALLOY T=0.15mm
 - 1.3 SHELL: COPPER ALLOY T=0.25mm
2. FINISH:
 - 2.1 CONTACT:
3u"Min. PLATED ON CONTACT AREA
G/F PLATING ON SOLDER TAIL AREA
50~80u"NICKEL UNDERPLATING OVERALL
 - 2.2 SHELL:
80~120u"MATTER TIN PLATING ALL
50~80u"NICKEL UNDERPLATING OVERALL
3. SPECIFICATION:
 - 3.1 CURRENT RATING: 1.0A MAX
 - 3.2 VOLTAGE: 100 VAC
 - 3.3 TEMPERATURE RANGE: -30 °C ~ 85 °C
 - 3.4 CONTACT RESISTANCE: 30 MILLIONHM MAX
 - 3.5 DIELECTRIC WITHSTANDING VOLTAGE: 200 VAC r.m.s
 - 3.6 INSULATION RESISTNACE: 100 MEGOHMS MIN.

6					PART NAME	MICRO USB JACK	* LV E LAKE-VIEW ELECTRONICS CO., LTD.			
5					PART No.	MCU-5F-O2FD				
4					DESIGNER	YAOFEI WANG	VIEW		UNIT	mm
3	SHELL	1	Copper	Ni-Plating	CHECKED BY	DELIANG LIU	VER	1.1	ANGLES	± 1.5°
2	TERMINALS	5	Copper	Ag-Plating	APPROVED BY	David Chen	SHEET	1 OF 1	TOLERANCE	30≤L ± 0.30
1	HOUSING	1	Hi-Temp UL94V-0 Black				DATE	'09.10.29		10≤L≤30 ± 0.25
NO.	DESCRIPTION	QTY	MATERIAL	PLATING						L≤10 ± 0.20